CHI YUN SCHOOL

2023-2024 School Year

CLP Underprivileged Families Electricity Subsidies Programme 2024

26th April, 2024

Dear Parents / Guardians,

CLP Power Hong Kong Limited (CLP) is now launching the captioned project to ease burden of underprivileged families through provision of a one-off electricity subsidy to qualified households. Beneficiaries would include elderly singleton or elderly doubletons, low-income families and people with disabilities in its supply area. Our school would join in as one of the partnered organizations.

When considering the application, your kind attention is drawn to information in the below:

- (1) The personal data of beneficiary is in name of the student.
- (2) Please provide i) a copy of your household CLP electricity bill
 - ii) a copy of <u>one</u> of the following as supporting documents of student for verification:
 - a. Registration Card for People with Disabilities; or
 - c. Comprehensive Social Security Assistance(CSSA) Scheme with Transport Supplement; *or*
 - c. Social Security Allowance (SSA) Scheme with Disability Allowance
- (3) All information must be accurately provided, otherwise, application may be rejected.
- (4) The application is solely to be approved by CLP. Even if application is submitted, subsidy may not be granted due to the quota full.

Those who are interested to apply, please kindly fill in the attached reply slip and return together the above mentioned supporting documents to our school <u>on or before 13th May 2024 (Monday) 4:00 pm</u>. The school will assist to submit the information to CLP for approval.

For further enquiry, please feel free to contact our school social worker, Ms. Kong or respective class teacher at 2386 2010. Thank you for your kind attention.

Yours faithfully,

Liu Hang Lam

Acting Principal, Chi Yun School

Reply Slip

I am (name)	(name)				, parent/guardian of student		
	ii	n class	S	, and	, and hereby acknowledge		
receipt of information Subsidies Programme.	regarding	2024	CLP	Underprivileged	Families	Electricity	
I would like to apply for reply slip together with the				•		•	
Signature :							
Contact Phone Number:							
Б.,							